Notice of Allowability	Application No.	Applicant(s)
	10/733,729	SCHWARZENBACH ET AL.
	Examiner	Art Unit
	David Nhu	2818
The MAILING DATE of this communication appears on the cover sheet with the correspondence address All claims being allowable, PROSECUTION ON THE MERITS IS (OR REMAINS) CLOSED in this application. If not included herewith (or previously mailed), a Notice of Allowance (PTOL-85) or other appropriate communication will be mailed in due course. THIS NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RIGHTS. This application is subject to withdrawal from issue at the initiative of the Office or upon petition by the applicant. See 37 CFR 1.313 and MPEP 1308.		
1. X This communication is responsive to 7/27/05.		
2. X The allowed claim(s) is/are <u>1-14 and 27-38.</u>		
3. ⊠ The drawings filed on <u>27 <i>July 2005</i></u> are accepted by the Examiner.		
 4. Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some* c) None of the: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 60/448,124. 3. Copies of the certified copies of the priority documents have been received in this national stage application from the International Bureau (PCT Rule 17.2(a)). * Certified copies not received: 		
Applicant has THREE MONTHS FROM THE "MAILING DATE" of this communication to file a reply complying with the requirements noted below. Failure to timely comply will result in ABANDONMENT of this application. THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.		
5. A SUBSTITUTE OATH OR DECLARATION must be submitted. Note the attached EXAMINER'S AMENDMENT or NOTICE OF INFORMAL PATENT APPLICATION (PTO-152) which gives reason(s) why the oath or declaration is deficient.		
 6. CORRECTED DRAWINGS (as "replacement sheets") must be submitted. (a) including changes required by the Notice of Draftsperson's Patent Drawing Review (PTO-948) attached 1) hereto or 2) to Paper No./Mail Date (b) including changes required by the attached Examiner's Amendment / Comment or in the Office action of Paper No./Mail Date Identifying indicia such as the application number (see 37 CFR 1.84(c)) should be written on the drawings in the front (not the back) of each sheet. Replacement sheet(s) should be labeled as such in the header according to 37 CFR 1.121(d). 		
7. DEPOSIT OF and/or INFORMATION about the deposit of BIOLOGICAL MATERIAL must be submitted. Note the attached Examiner's comment regarding REQUIREMENT FOR THE DEPOSIT OF BIOLOGICAL MATERIAL.		
Attachment(s) 1. ☐ Notice of References Cited (PTO-892) 2. ☐ Notice of Draftperson's Patent Drawing Review (PTO-948) 3. ☐ Information Disclosure Statements (PTO-1449 or PTO/SB/0 Paper No./Mail Date 4. ☐ Examiner's Comment Regarding Requirement for Deposit of Biological Material	6. ☐ Interview Summary Paper No./Mail Dat 8), 7. ☐ Examiner's Amendr	te nent/Comment ent of Reasons for Allowance

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REASONS FOR ALLOWANCE

1. Claims 1-14, 27-38 are allowed.

The following is an examiner's statement of reasons for allowance: None of the references of record teaches or suggests in claims 1, 6, 10: A method of making a semiconductor structure having a surface layer of a first material, a sub-surface layer of a second, different material, and a supporting substrate, which method comprises: selectively implanting atoms through the surface layer and at least a portion of the sub-surface layer to render the first and second materials receptive to removal by etching; and selectively etching the portion of the sub-surface layer through which atoms have been implanted in order to form a cavity beneath the surface layer (as cited in claim 1); selectively implanting atoms through the surface layer and at least a portion of the sub-surface layer to render the first and second materials receptive to removal by etching, wherein the selective implantation of atoms is obtained by masking a portion of the surface layer and implanting atoms in a zone that has a shape that corresponds with a non-masked portion of the surface layer; and selectively etching the portion of the sub-surface layer through which atoms have been implanted in order to form a cavity beneath the surface layer (as cited in claim 6); selectively implanting atoms through the surface layer and at least a portion of the sub-surface layer to render the first and second materials receptive to removal by etching; forming at least one hole in the surface layer to a depth that leads to the sub-surface layer; and selectively etching the portion of the sub-surface layer through which atoms have been implanted in order to form a cavity beneath the surface layer (as cited in claim 10).

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3. Any comments considered necessary by applicant must be submitted no later than the

payment of the issue fee and, to avoid processing delays, should preferably accompany the

issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons

for Allowance."

CONCLUSION

4. The prior art made of record and not relied upon is considered pertinent to applicant's

disclosure: Sakaguchi et al (6,569,748 B1): Substrate and Production Method Thereof.

5. Any inquiry concerning this communication on earlier communications from the examiner

should be directed to David Nhu, (571)272-1792. The examiner can normally be reached

on Monday-Friday from 7:30 AM to 5:00 PM.

The examiner's supervisor, David Nelms can be reached on (571)272-1787.

The fax phone number for the organization where this application or proceeding is assigned

is (703)872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should

be directed to the receptionist whose telephone number is (703) 308-0956.

David Nhu

BU

August 3, 2005

DAVID NHU

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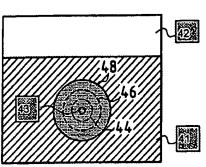
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FIG.3A

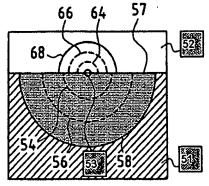


FIG.3B

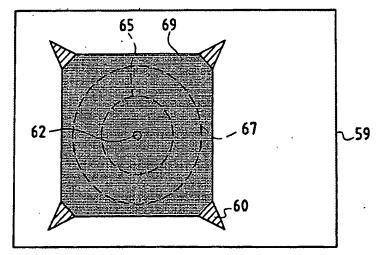


FIG.3C

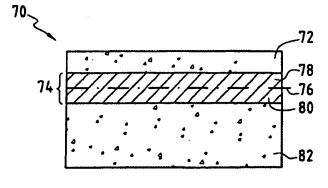


FIG.5